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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

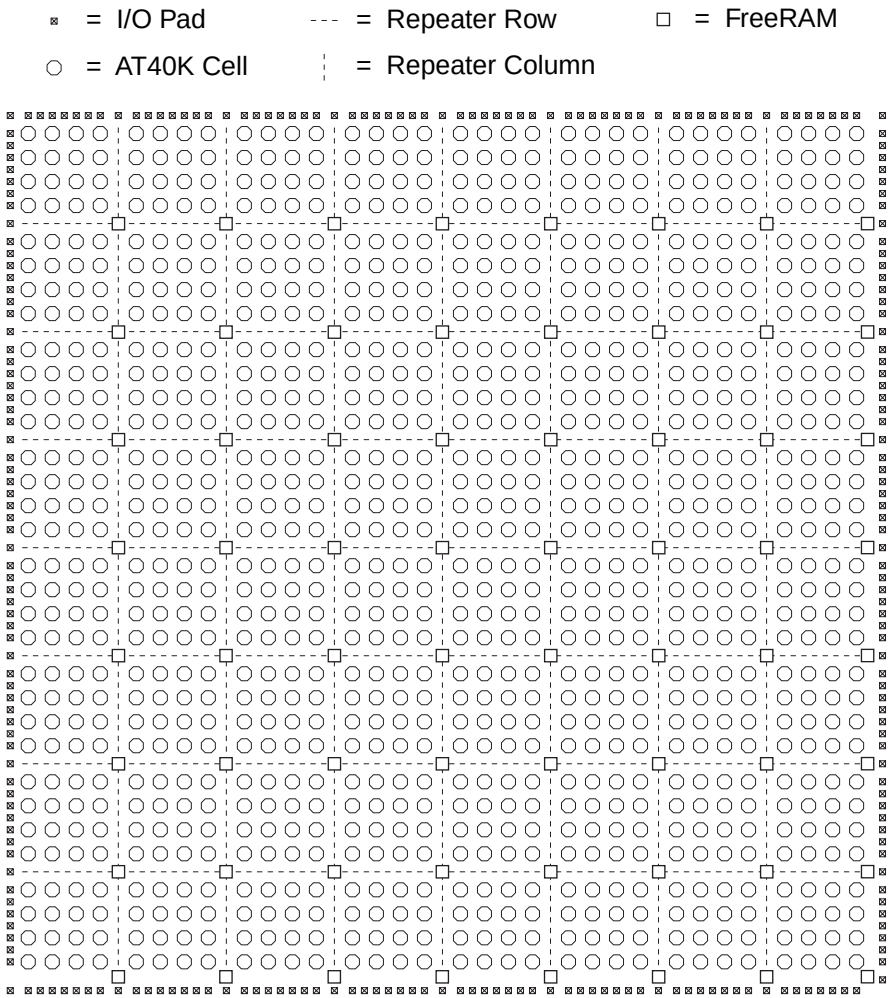
Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	1024
Total RAM Bits	8192
Number of I/O	78
Number of Gates	30000
Voltage - Supply	3V ~ 3.6V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/at40k20al-1aqc

The Symmetrical Array

At the heart of the Atmel architecture is a symmetrical array of identical cells, see Figure 1. The array is continuous from one edge to the other, except for bus repeaters spaced every four cells, see Figure 2 on page 5. At the intersection of each repeater row and column there is a 32 x 4 RAM block accessible by adjacent buses. The RAM can be configured as either a single-ported or dual-ported RAM(1), with either synchronous or asynchronous operation.

Note: 1. The right-most column can only be used as single-port RAM.

Figure 1. Symmetrical Array Surrounded by I/O (AT40K20AL)(1)



Note: 1. AT40KAL has registered I/Os. Group enable on every sector for tri-states on obufe's.

The Busing Network

Figure 3 on page 7 depicts one of five identical busing planes. Each plane has three bus resources: a local-bus resource (the middle bus) and two express-bus (both sides) resources. Bus resources are connected via repeaters. Each repeater has connections to two adjacent local-bus segments and two express-bus segments. Each local-bus segment spans four cells and connects to consecutive repeaters. Each express-bus segment spans eight cells and “leapfrogs” or bypasses a repeater. Repeaters regenerate signals and can connect any bus to any other bus (all pathways are legal) on the same plane. Although not shown, a local bus can bypass a repeater via a programmable pass gate allowing long on-chip tri-state buses to be created. Local/Local turns are implemented through pass gates in the cell-bus interface. Express/Express turns are implemented through separate pass gates distributed throughout the array.

Some of the bus resources on the AT40KAL are used as a dual-function resources. Table 2 shows which buses are used in a dual-function mode and which bus plane is used. The AT40KAL software tools are designed to accommodate dual-function buses in an efficient manner.

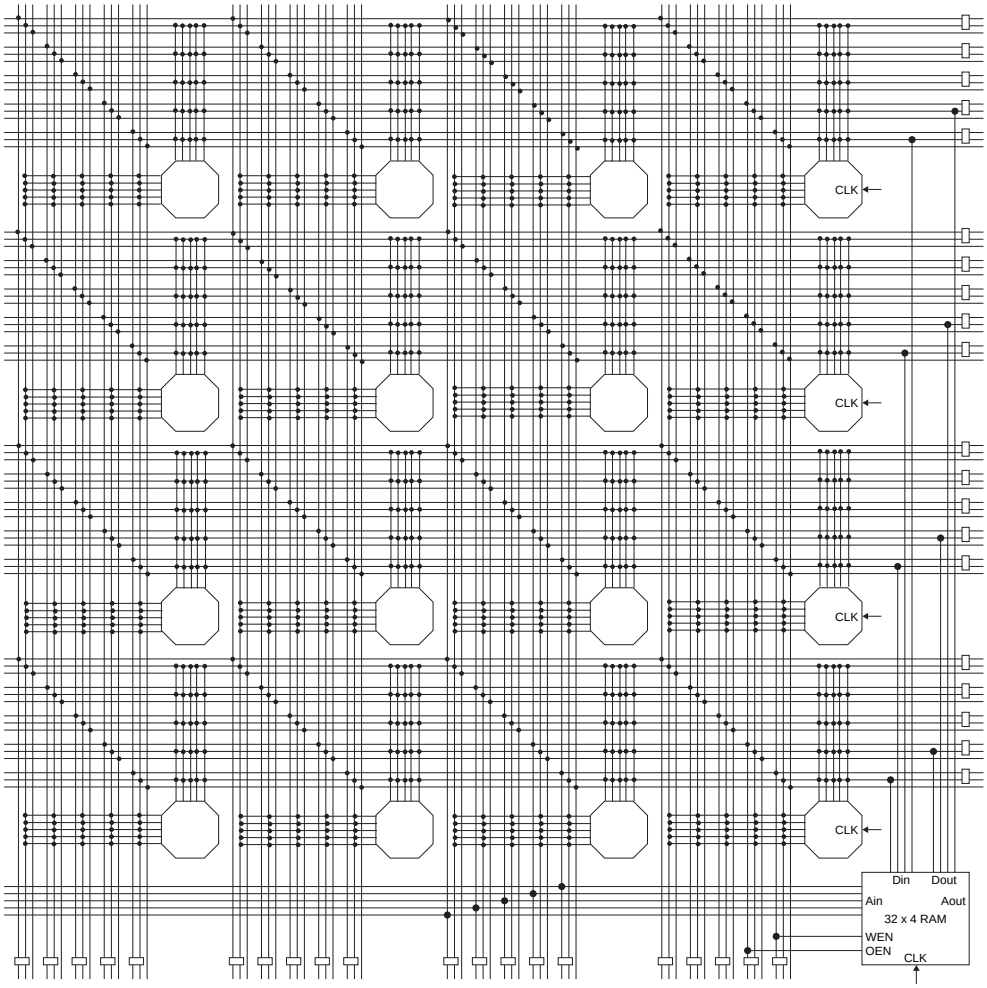
Table 2. Dual-function Buses

Function	Type	Plane(s)	Direction	Comments
Cell Output Enable	Local	5	Horizontal and Vertical	
RAM Output Enable	Express	2	Vertical	Bus full length at array edge Bus in first column to left of RAM block
RAM Write Enable	Express	1	Vertical	Bus full length at array edge Bus in first column to left of RAM block
RAM Address	Express	1 - 5	Vertical	Buses full length at array edge Buses in second column to left of RAM block
RAM Data In	Local	1	Horizontal	Data In connects to local bus plane 1
RAM Data Out	Local	2	Horizontal	Data out connects to local bus plane 2
Clocking	Express	4	Vertical	Bus half length at array edge
Set/Reset	Express	5	Vertical	Bus half length at array edge

RAM

32 x 4 dual-ported RAM blocks are dispersed throughout the array, see Figure 7. A 4-bit Input Data Bus connects to four horizontal local buses distributed over four sector rows (plane 1). A 4-bit Output Data Bus connects to four horizontal local buses distributed over four sector rows (plane 2). A 5-bit Input Address Bus connects to five vertical express buses in the same column. A 5-bit Output Address Bus connects to five vertical express buses in the same column. Ain (input address) and Aout (output address) alternate positions in horizontally aligned RAM blocks. For the left-most RAM blocks, Aout is on the left and Ain is on the right. For the right-most RAM blocks, Ain is on the left and Aout is tied off, thus it can only be configured as a single port. For single-ported RAM, Ain is the READ/WRITE address port and Din is the (bi-directional) data port. Right-most RAM blocks can be used only for single-ported memories. WEN and OEN connect to the vertical express buses in the same column.

Figure 7. RAM Connections (One Ram Block)



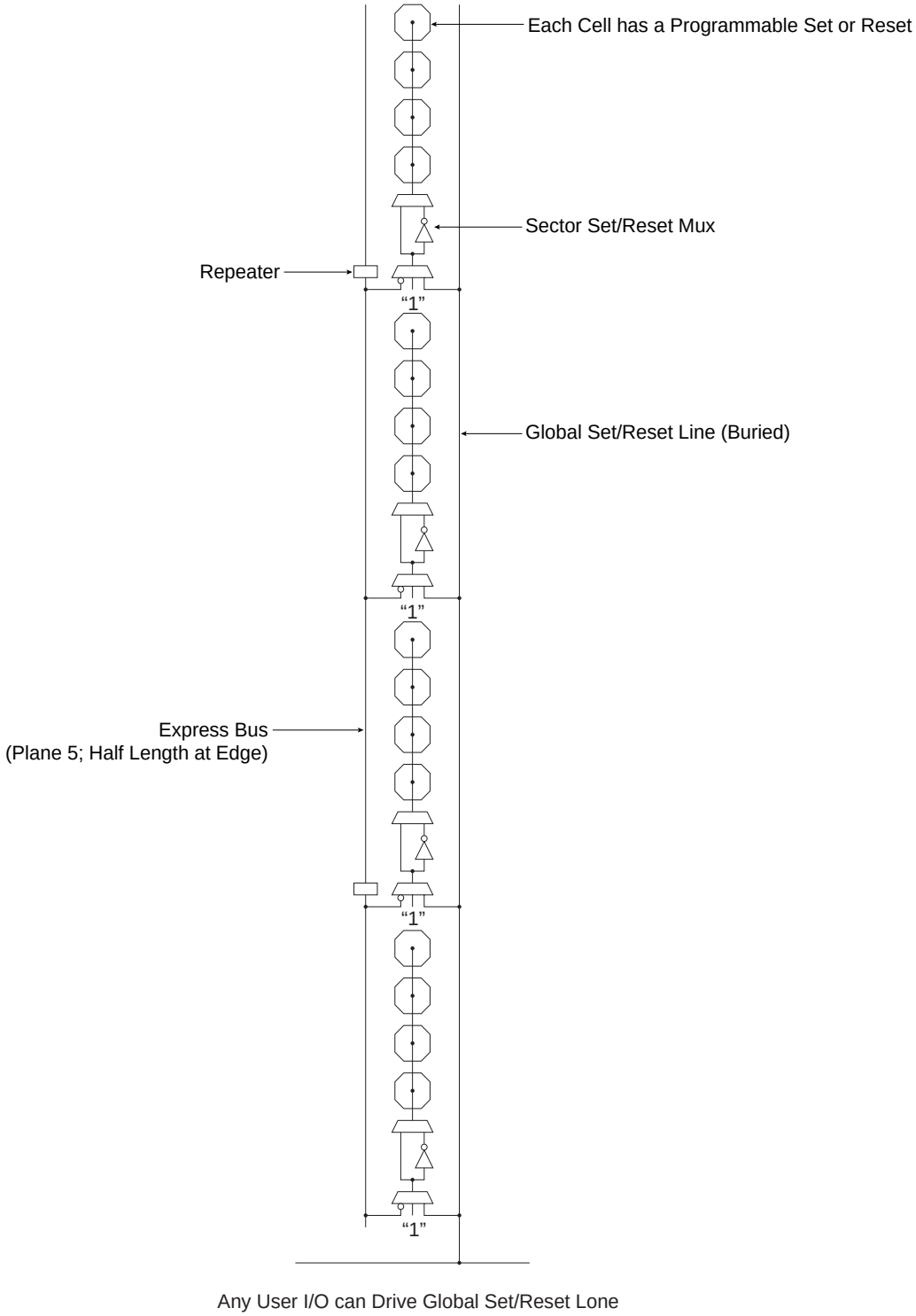
Set/Reset Scheme

The AT40KAL family reset scheme is essentially the same as the clock scheme except that there is only one Global Reset. A dedicated Global Set/Reset bus can be driven by any User I/O, except those used for clocking (Global Clocks or Fast Clocks). The automatic placement tool will choose the reset net with the most connections to use the global resources. You can change this by using an RSBUF component in your design to indicate the global reset. Additional resets will use the express bus network.

The Global Set/Reset is distributed to each column of the array. Like Sector Clock mux, there is Sector Set/Reset mux at every four cells. Each sector column of four cells is set/reset by a Plane 5 express bus or Global Set/Reset using the Sector Set/Reset mux, see Figure 11 on page 17. The set/reset provided to each sector column of four cells is either inverted or non-inverted using the Sector Reset mux.

The function of the Set/Reset input of a register is determined by a configuration bit in each cell. The Set/Reset input of a register is active low (logic 0) by default. Setting or Resetting of a register is asynchronous. Before configuration on power-up, a logic 1 (a high) is provided by each register (i.e., all registers are set at power-up).

Figure 11. Set/Reset (for One Column of Cells)



Primary, Secondary and Corner I/Os

The AT40KAL has three kinds of I/Os: Primary I/O, Secondary I/O and a Corner I/O. Every edge cell except corner cells on the AT40KAL has access to one Primary I/O and two Secondary I/Os.

Primary I/O

Every logic cell at the edge of the FPGA array has a direct orthogonal connection to and from a Primary I/O cell. The Primary I/O interfaces directly to its adjacent core cell. It also connects into the repeaters on the row immediately above and below the adjacent core cell. In addition, each Primary I/O also connects into the busing network of the three nearest edge cells. This is an extremely powerful feature, as it provides logic cells toward the center of the array with fast access to I/Os via local and express buses. It can be seen from the diagram that a given Primary I/O can be accessed from any logic cell on three separate rows or columns of the FPGA. See Figure 12 on page 20.

Secondary I/O

Every logic cell at the edge of the FPGA array has two direct diagonal connections to a Secondary I/O cell. The Secondary I/O is located between core cell locations. This I/O connects on the diagonal inputs to the cell above and the cell below. It also connects to the repeater of the cell above and below. In addition, each Secondary I/O also connects into the busing network of the two nearest edge cells. This is an extremely powerful feature, as it provides logic cells toward the center of the array with fast access to I/Os via local and express buses. It can be seen from the diagram that a given Secondary I/O can be accessed from any logic cell on two rows or columns of the FPGA. See Figure 13 on page 20.

Corner I/O

Logic cells at the corner of the FPGA array have direct-connect access to five separate I/Os: 2 Primary, 2 Secondary and 1 Corner I/O. Corner I/Os are like an extra Secondary I/O at each corner of the array. With the inclusion of Corner I/Os, an AT40KAL FPGA with n x n core cells always has 8n I/Os. As the diagram shows, Corner I/Os can be accessed both from the corner logic cell and the horizontal and vertical busing networks running along the edges of the array. This means that many different edge logic cells can access the Corner I/Os. See Figure 14 on page 21.

Figure 12. West Primary I/O (Mirrored for East I/O)

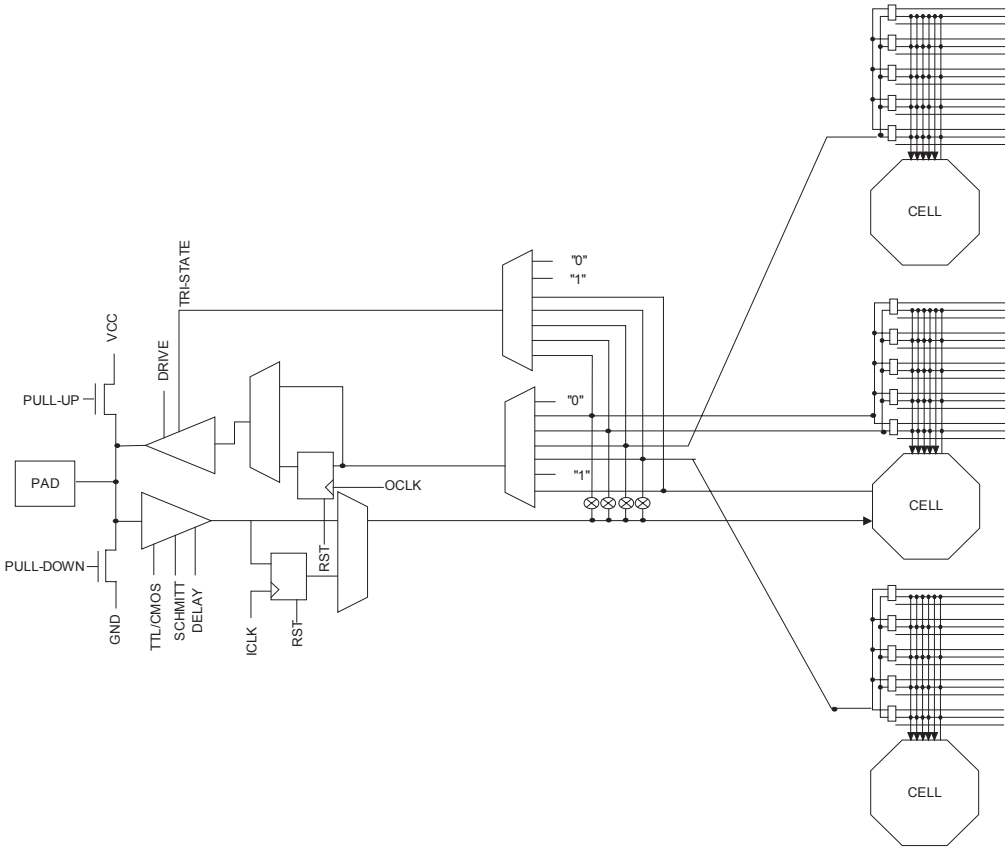


Figure 13. West Secondary I/O (Mirrored for East I/O)

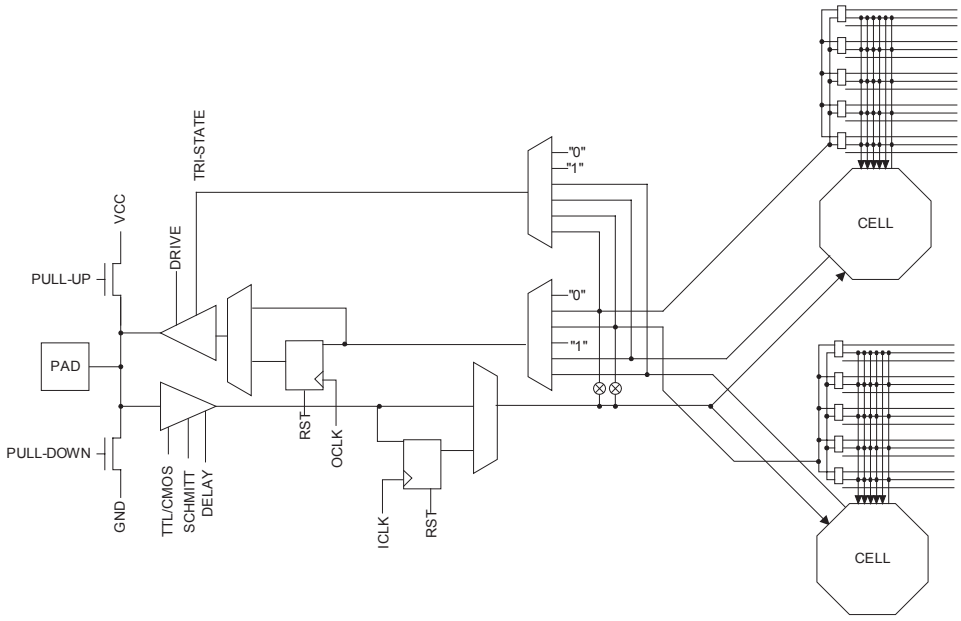
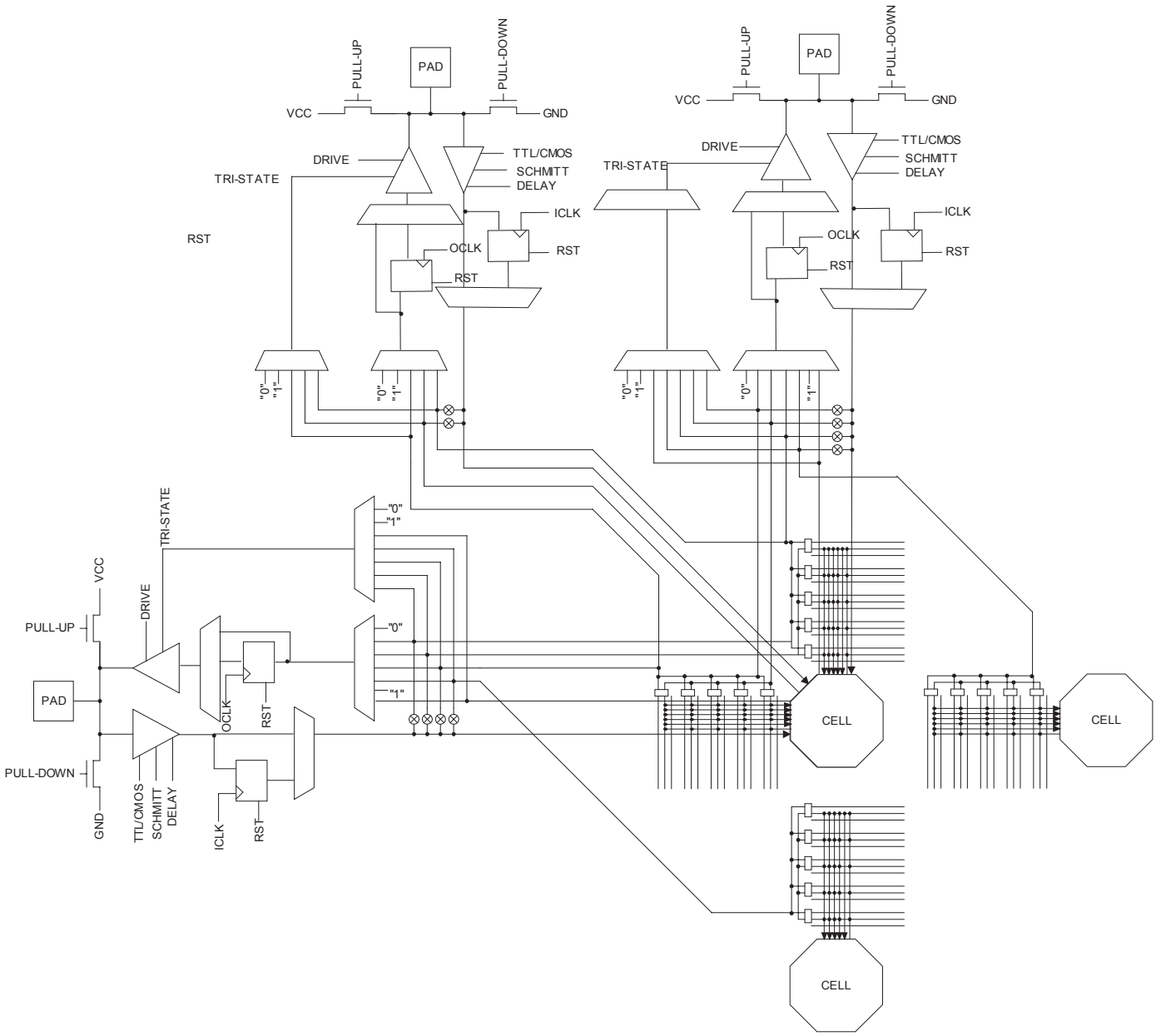


Figure 14. Northwest Corner I/O (Similar NE/SE/SW Corners)



DC Characteristics – 3.3V Operation Commercial/Industrial

Symbol	Parameter	Conditions	Minimum	Typical	Maximum	Units
V_{IH}	High-level Input Voltage	CMOS	0.7 V_{CC}		5.5V	V
V_{IL}	Low-level Input Voltage	CMOS	-0.3		30% V_{CC}	V
V_{OH}	High-level Output Voltage	I_{OH} = 4 mA V_{CC} = V_{CC} minimum	2.1			V
		I_{OH} = 12 mA V_{CC} = 3.0V	2.1			V
		I_{OH} = 16 mA V_{CC} = 3.0V	2.1			V
V_{OL}	Low-level Output Voltage	I_{OL} = -4 mA V_{CC} = 3.0V			0.4	V
		I_{OL} = -12 mA V_{CC} = 3.0V			0.4	V
		I_{OL} = -16 mA V_{CC} = 3.0V			0.4	V
I_{IH}	High-level Input Current	V_{IN} = V_{CC} Maximum			10.0	µA
		With pull-down, V_{IN} = V_{CC}	75.0	150.0	300.0	µA
I_{IL}	Low-level Input Current	V_{IN} = V_{SS}	-10.0			µA
		With pull-up, V_{IN} = V_{SS}	-300.0	-150.0	-75.0	µA
I_{OZH}	High-level Tri-state Output Leakage Current	Without pull-down, V_{IN} = V_{CC} Maximum			10.0	µA
		With pull-down, V_{IN} = V_{CC} Maximum	75.0	150.0	300.0	µA
I_{OZL}	Low-level Tri-state Output Leakage Current	Without pull-up, V_{IN} = V_{SS}	-10.0			mA
		With pull-up, V_{IN} = V_{SS}	CON = -500 µA TO -125 µA	-150.0	CON = -500 µA TO -125 µA	µA
I_{CC}	Standby Current Consumption	Standby, unprogrammed		0.6	1.0	mA
C_{IN}	Input Capacitance	All pins			10.0	pF

Note: 1. Parameter based on characterization and simulation; it is not tested in production.

AC Timing Characteristics – 3.3V Operation

Delays are based on fixed loads and are described in the notes.
Maximum times based on worst case: V_{CC} = 3.0V, temperature = 70°C
Minimum times based on best case: V_{CC} = 3.6V, temperature = 0°C
Maximum delays are the average of t_{PDLH} and t_{PDHL}.

All input IO characteristics measured from a V_{IH} of 50% of V_{DD} at the pad (CMOS threshold) to the internal V_{IH} of 50% of V_{DD}. All output IO characteristics are measured as the average of t_{PDLH} and t_{PDHL} to the pad V_{IH} of 50% of V_{DD}.

Cell Function	Parameter	Path	-1	Units	Notes
Repeaters					
Repeater	t_{PD} (Maximum)	L -> E	1.3	ns	1 unit load
Repeater	t_{PD} (Maximum)	E -> E	1.3	ns	1 unit load
Repeater	t_{PD} (Maximum)	L -> L	1.3	ns	1 unit load
Repeater	t_{PD} (Maximum)	E -> L	1.3	ns	1 unit load
Repeater	t_{PD} (Maximum)	E -> IO	0.8	ns	1 unit load
Repeater	t_{PD} (Maximum)	L -> IO	0.8	ns	1 unit load

All input IO characteristics measured from a V_{IH} of 50% of V_{DD} at the pad (CMOS threshold) to the internal V_{IH} of 50% of V_{DD}. All output IO characteristics are measured as the average of t_{PDLH} and t_{PDHL} to the pad V_{IH} of 50% of V_{DD}.

Cell Function	Parameter	Path	-1	Units	Notes
IO					
Input	t_{PD} (Maximum)	pad -> x/y	1.2	ns	No extra delay
Input	t_{PD} (Maximum)	pad -> x/y	3.6	ns	1 extra delay
Input	t_{PD} (Maximum)	pad -> x/y	7.3	ns	2 extra delays
Input	t_{PD} (Maximum)	pad -> x/y	10.8	ns	3 extra delays
Output, Slow	t_{PD} (Maximum)	x/y/E/L -> pad	5.9	ns	50 pf load
Output, Medium	t_{PD} (Maximum)	x/y/E/L -> pad	4.8	ns	50 pf load
Output, Fast	t_{PD} (Maximum)	x/y/E/L -> pad	3.9	ns	50 pf load
Output, Slow	t_{PZX} (Maximum)	oe -> pad	6.2	ns	50 pf load
Output, Slow	t_{PXZ} (Maximum)	oe -> pad	1.3	ns	50 pf load
Output, Medium	t_{PZX} (Maximum)	oe -> pad	4.8	ns	50 pf load
Output, Medium	t_{PXZ} (Maximum)	oe -> pad	1.9	ns	50 pf load
Output, Fast	t_{PZX} (Maximum)	oe -> pad	3.7	ns	50 pf load
Output, Fast	t_{PXZ} (Maximum)	oe -> pad	1.6	ns	50 pf load

AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Left Side (Top to Bottom)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
I/O9, FCK1	I/O13, FCK1	I/O17, FCK1	I/O25, FCK1			9	15	15
I/O10	I/O14	I/O18	I/O26			10	16	16
I/O11 (A20)	I/O15 (A20)	I/O19 (A20)	I/O27 (A20)	17	6	11	17	17
I/O12 (A21)	I/O16 (A21)	I/O20 (A21)	I/O28 (A21)	18	7	12	18	18
	VCC	VCC	VCC					19
	I/O17	I/O21	I/O29					20
	I/O18	I/O22	I/O30					21
			GND					
			I/O31					
			I/O32					
			I/O33					
			I/O34					
		I/O23	I/O35					
		I/O24	I/O36					
		GND	GND					22
			VCC					
			I/O37					
			I/O38					
		I/O25	I/O39					
		I/O26	I/O40					
	I/O19	I/O27	I/O41				19	23
	I/O20	I/O28	I/O42				20	24
			GND					
I/O13	I/O21	I/O29	I/O43			13	21	25
I/O14	I/O22	I/O30	I/O44		8	14	22	26
			I/O45					
			I/O46					
I/O15 (A22)	I/O23 (A22)	I/O31 (A22)	I/O47 (A22)	19	9	15	23	27
I/O16 (A23)	I/O24 (A23)	I/O32 (A23)	I/O48 (A23)	20	10	16	24	28
GND	GND	GND	GND	21	11	17	25	29
VCC	VCC	VCC	VCC	22	12	18	26	30

Note: 1. On-chip tri-state

AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Left Side (Top to Bottom)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
I/O17	I/O25	I/O33	I/O49	23	13	19	27	31
I/O18	I/O26	I/O34	I/O50	24	14	20	28	32
			I/O51					
			I/O52					
I/O19	I/O27	I/O35	I/O53		15	21	29	33
I/O20	I/O28	I/O36	I/O54			22	30	34
			GND					
	I/O29	I/O37	I/O55				31	35
	I/O30	I/O38	I/O56				32	36
		I/O39	I/O57					
		I/O40	I/O58					
			I/O59					
			I/O60					
			VCC					
		GND	GND					37
		I/O41	I/O61					
		I/O42	I/O62					
			I/O63					
			I/O64					
			I/O65					
			I/O66					
			GND					
	I/O31	I/O43	I/O67					38
	I/O32	I/O44	I/O68					39
	VCC	VCC	VCC					40
I/O21	I/O33	I/O45	I/O69	25	16	23	33	41
I/O22	I/O34	I/O46	I/O70	26	17	24	34	42
I/O23	I/O35	I/O47	I/O71			25	35	43
I/O24, FCK2	I/O36, FCK2	I/O48, FCK2	I/O72, FCK2			26	36	44
GND	GND	GND	GND			27	37	45
		I/O49	I/O73					
		I/O50	I/O74					
	I/O37	I/O51	I/O75					46

Note: 1. On-chip tri-state

AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Bottom Side (Left to Right)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
I/O42	I/O62	I/O82	I/O122			47	69	77
I/O43	I/O63	I/O83	I/O123	38	31	48	70	78
I/O44	I/O64	I/O84	I/O124	39	32	49	71	79
	VCC	VCC	VCC					80
	I/O65	I/O85	I/O125				72	81
	I/O66	I/O86	I/O126				73	82
			GND					
			I/O127					
			I/O128					
			I/O129					
			I/O130					
		I/O87	I/O131					
		I/O88	I/O132					
		GND	GND					83
			VCC					
		I/O89	I/O133					
		I/O90	I/O134					
	I/O67	I/O91	I/O135					84
	I/O68	I/O92	I/O136					85
I/O45	I/O69	I/O93	I/O137		33	50	74	86
I/O46	I/O70	I/O94	I/O138		34	51	75	87
			GND					
			I/O139					
			I/O140					
			I/O141					
			I/O142					
I/O47 (D15)	I/O71 (D15)	I/O95 (D15)	I/O143 (D15)	40	35	52	76	88
I/O48 (INIT)	I/O72 (INIT)	I/O96 (INIT)	I/O144 (INIT)	41	36	53	77	89
VCC	VCC	VCC	VCC	42	37	54	78	90
GND	GND	GND	GND	43	38	55	79	91
I/O49 (D14)	I/O73 (D14)	I/O97 (D14)	I/O145 (D14)	44	39	56	80	92
I/O50 (D13)	I/O74 (D13)	I/O98 (D13)	I/O146 (D13)	45	40	57	81	93

AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Bottom Side (Left to Right)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
			I/O147					
			I/O148					
			I/O149					
			I/O150					
			GND					
I/O51	I/O75	I/O99	I/O151		41	58	82	94
I/O52	I/O76	I/O100	I/O152		42	59	83	95
	I/O77	I/O101	I/O153				84	96
	I/O78	I/O102	I/O154				85	97
		I/O103	I/O155					
		I/O104	I/O156					
			VCC					
		GND	GND					98
		I/O105	I/O157					
		I/O106	I/O158					
			I/O159					
			I/O160					
			I/O161					
			I/O162					
			GND					
	I/O79	I/O107	I/O163					99
	I/O80	I/O108	I/O164					100
	VCC	VCC	VCC					101
I/O53 (D12)	I/O81 (D12)	I/O109 (D12)	I/O165 (D12)	46	43	60	86	102
I/O54 (D11)	I/O82 (D11)	I/O110 (D11)	I/O166 (D11)	47	44	61	87	103
I/O55	I/O83	I/O111	I/O167			62	88	104
I/O56	I/O84	I/O112	I/O168			63	89	105
GND	GND	GND	GND			64	90	106
		I/O113	I/O169					
		I/O114	I/O170					
	I/O85	I/O115	I/O171					107
	I/O86	I/O116	I/O172					108
			I/O173					

AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Right Side (Bottom to Top)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
			I/O243					
			I/O244					
I/O83	I/O123	I/O163	I/O245		67	94	134	154
I/O84	I/O124	I/O164	I/O246			95	135	155
			GND					
	I/O125	I/O165	I/O247				136	156
	I/O126	I/O166	I/O248				137	157
		I/O167	I/O249					
		I/O168	I/O250					
			I/O251					
			I/O252					
			VCC					
		GND	GND					158
		I/O169	I/O253					
		I/O170	I/O254					
			I/O255					
			I/O256					
			I/O257					
			I/O258					
			GND					
I/O85 (D2)	I/O127 (D2)	I/O171 (D2)	I/O259 (D2)	67	68	96	138	159
I/O86	I/O128	I/O172	I/O260	68	69	97	139	160
	VCC	VCC	VCC					161
I/O87	I/O129	I/O173	I/O261			98	140	162
I/O88, FCK4	I/O130, FCK4	I/O174, FCK4	I/O262, FCK4			99	141	163
	I/O131	I/O175	I/O263					164
	I/O132	I/O176	I/O264					165
GND	GND	GND	GND			100	142	166
		I/O177	I/O265					
		I/O178	I/O266					
	I/O133	I/O179	I/O267					167
	I/O134	I/O180	I/O268					168
			I/O269					

AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Right Side (Bottom to Top)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
			I/O270					
			GND					
	I/O135	I/O181	I/O271				143	169
	I/O136	I/O182	I/O272				144	170
I/O89	I/O137	I/O183	I/O273				145	171
I/O90	I/O138	I/O184	I/O274				146	172
			I/O275					
			I/O276					
		GND	GND					
		VCC	VCC					
I/O91 (D1)	I/O139 (D1)	I/O185 (D1)	I/O277 (D1)	69	70	101	147	173
I/O92	I/O140	I/O186	I/O278	70	71	102	148	174
			I/O279					
			I/O280					
			I/O281					
			I/O282					
			GND					
		I/O187	I/O283					
		I/O188	I/O284					
I/O93	I/O141	I/O189	I/O285			103	149	175
I/O94	I/O142	I/O190	I/O286			104	150	176
I/O95 (D0)	I/O143 (D0)	I/O191 (D0)	I/O287 (D0)	71	72	105	151	177
I/O96, GCK6 ($\overline{\text{CSOUT}}$)	I/O144, GCK6 ($\overline{\text{CSOUT}}$)	I/O192, GCK6 ($\overline{\text{CSOUT}}$)	I/O288, GCK6 ($\overline{\text{CSOUT}}$)	72	73	106	152	178
CCLK	CCLK	CCLK	CCLK	73	74	107	153	179
VCC	VCC	VCC	VCC	74	75	108	154	180
TSTCLK	TSTCLK	TSTCLK	TSTCLK	75	76	109	159	181

AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Top Side (Right to Left)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
GND	GND	GND	GND	76	77	110	160	182
I/O97 (A0)	I/O145 (A0)	I/O193 (A0)	I/O289 (A0)	77	78	111	161	183
I/O98, GCK7 (A1)	I/O146, GCK7 (A1)	I/O194, GCK7 (A1)	I/O290, GCK7 (A1)	78	79	112	162	184
I/O99	I/O147	I/O195	I/O291			113	163	185
I/O100	I/O148	I/O196	I/O292			114	164	186
			I/O293					
			I/O294					
			GND					
			I/O295					
			I/O296					
I/O101 ($\overline{CS1}$,A2)	I/O149 ($\overline{CS1}$,A2)	I/O197 ($\overline{CS1}$,A2)	I/O297 ($\overline{CS1}$,A2)	79	80	115	165	187
I/O102 (A3)	I/O150 (A3)	I/O198 (A3)	I/O298 (A3)	80	81	116	166	188
		I/O199	I/O299					
		I/O200	I/O300					
		VCC	VCC					
		GND	GND					
	I/O151[1]	I/O201[1]	I/O301[1]	75[1] NC	76[1] NC	109[1] NC	159[1] NC	189[1] NC
	I/O152	I/O202	I/O302					190
I/O103	I/O153	I/O203	I/O303			117	167	191
I/O104[1]	I/O154	I/O204	I/O304				168	192
			I/O305					
			I/O306					
			GND					
			I/O307					
			I/O308					
	I/O155	I/O205	I/O309				169	193
	I/O156	I/O206	I/O310				170	194
		I/O207	I/O311					195
		I/O208	I/O312					
GND	GND	GND	GND			118	171	196

Note: 1. Shared with TSTCLK. No Connect.

AT40K05AL Ordering Information

Usable Gates	Operating Voltage	Speed Grade (ns)	Ordering Code	Package	Operation Range[1]
5,000 - 10,000	3.3V	1	AT40K05AL-1AJC AT40K05AL-1AQC AT40K05AL-1BQC AT40K05AL-1DQC	84J 100T1 144L1 208Q1	Commercial (0°C to 70°C)
5,000 - 10,000	3.3V	1	AT40K05AL-1AJI AT40K05AL-1AQI AT40K05AL-1BQI AT40K05AL-1DQI	84J 100T1 144L1 208Q1	Industrial (-40°C to 85°C)

AT40K10AL Ordering Information

Usable Gates	Operating Voltage	Speed Grade (ns)	Ordering Code	Package	Operation Range[1]
10,000 - 20,000	3.3V	1	AT40K10AL-1AJC AT40K10AL-1AQC AT40K10AL-1BQC AT40K10AL-1DQC	84J 100T1 144L1 208Q1	Commercial (0°C to 70°C)
10,000 - 20,000	3.3V	1	AT40K10AL-1AJI AT40K10AL-1AQI AT40K10AL-1BQI AT40K10AL-1DQI	84J 100T1 144L1 208Q1	Industrial (-40°C to 85°C)

AT40K20AL Ordering Information

Usable Gates	Operating Voltage	Speed Grade (ns)	Ordering Code	Package	Operation Range[1]
20,000 - 30,000	3.3V	1	AT40K20AL-1AJC AT40K20AL-1AQC AT40K20AL-1BQC AT40K20AL-1DQC	84J 100T1 144L1 208Q1	Commercial (0°C to 70°C)
20,000 - 30,000	3.3V	1	AT40K20AL-1AJI AT40K20AL-1AQI AT40K20AL-1BQI AT40K20AL-1DQI	84J 100T1 144L1 208Q1	Industrial (-40°C to 85°C)

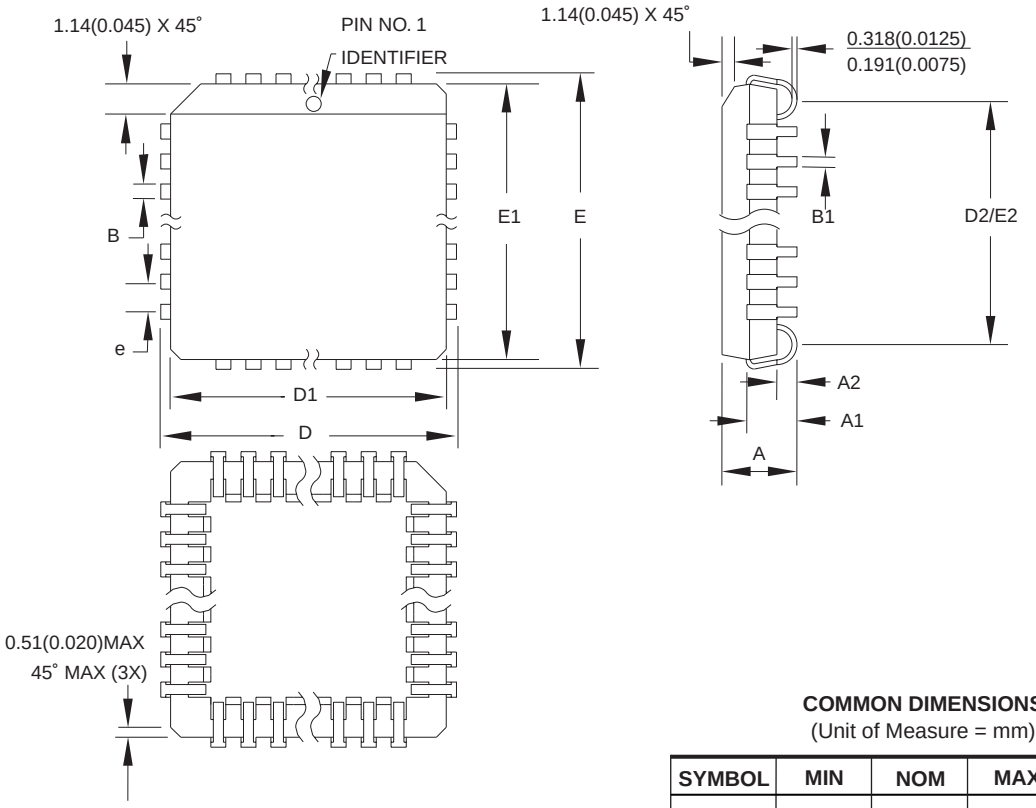
AT40K40AL Ordering Information

Usable Gates	Operating Voltage	Speed Grade (ns)	Ordering Code	Package	Operation Range[1]
40,000 - 50,000	3.3V	1	AT40K40AL-1BQC AT40K40AL-1DQC AT40K40AL-1EQC	144L1 208Q1 240Q1	Commercial (0°C to 70°C)
40,000 - 50,000	3.3V	1	AT40K40AL-1BQI AT40K40AL-1DQI AT40K40AL-1EQI	144L1 208Q1 240Q1	Industrial (-40°C to 85°C)

Note: 1. For military parts, contact Atmel at fpga@atmel.com.

Packaging Information

84J – PLCC



COMMON DIMENSIONS
(Unit of Measure = mm)

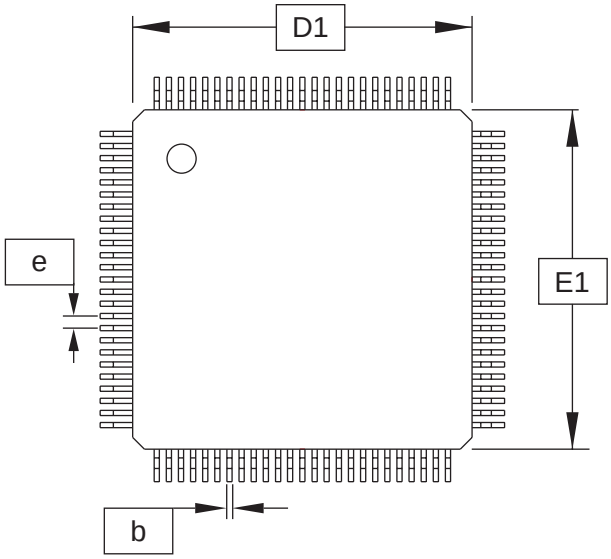
SYMBOL	MIN	NOM	MAX	NOTE
A	4.191	–	4.572	
A1	2.286	–	3.048	
A2	0.508	–	–	
D	30.099	–	30.353	
D1	29.210	–	29.413	Note 2
E	30.099	–	30.353	
E1	29.210	–	29.413	Note 2
D2/E2	27.686	–	28.702	
B	0.660	–	0.813	
B1	0.330	–	0.533	
e	1.270 TYP			

Notes:
1. This package conforms to JEDEC reference MS-018, Variation AF.
2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is .010"(0.254 mm) per side. Dimension D1 and E1 include mold mismatch and are measured at the extreme material condition at the upper or lower parting line.
3. Lead coplanarity is 0.004" (0.102 mm) maximum.

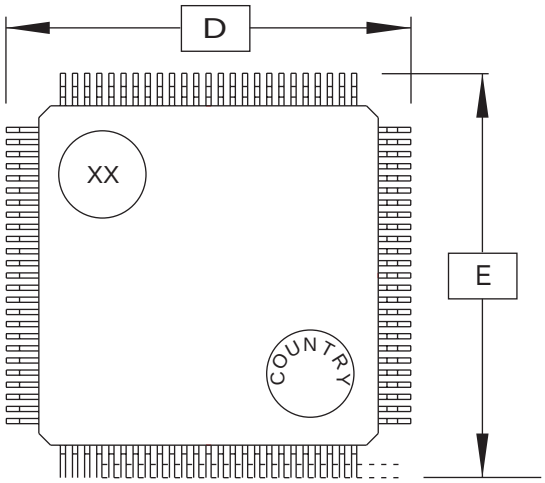
10/04/01

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**84J**, 84-lead, Plastic J-leaded Chip Carrier (PLCC)	84J	B

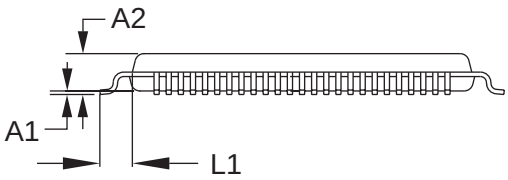
100T1 – TQFP



Top View



Bottom View



Side View

COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A1	0.05		0.15	6
A2	0.95	1.00	1.05	
D		16.00 BSC		
D1		14.00 BSC		2, 3
E		16.00 BSC		
E1		14.00 BSC		2, 3
e		0.50 BSC		
b	0.17	0.22	0.27	4, 5
L1		1.00 REF		

Notes:
1. This drawing is for general information only. Refer to JEDEC Drawing MO-153, Variation AA, for proper dimensions, tolerances, datums, etc.
2. The top package body size may be smaller than the bottom package size by as much as 0.15 mm.
3. Dimensions D1 and E1 do not include mold protrusions. Allowable protrusion is 0.25 mm per side. D1 and E1 are maximum plastic body size dimensions, including mold mismatch.
4. Dimension b does not include Dambar protrusion. Allowable Dambar protrusion shall not cause the lead width to exceed the maximum b dimension by more than 0.08 mm. Dambar cannot be located on the lower radius or the foot. Minimum space between protrusion and an adjacent lead is 0.07 mm for 0.4 and 0.5 mm pitch packages.
5. These dimensions apply to the flat section of the lead between 0.10 mm and 0.25 mm from the lead tip.
6. A1 is defined as the distance from the seating place to the lowest point on the package body.

11/30/01

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**100T1**, 100-lead (14 x 14 x 1.0 mm Body), Thin Plastic Quad Flat Pack (TQFP)	100T1	A